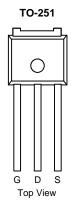


IRFU9010P-VB Datasheet

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
- 60	0.066 at V _{GS} = - 10 V	- 20	40 nC		
- 00	0.080 at V _{GS} = - 4.5 V	- 18	40110		



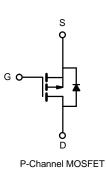
FEATURES

- Trench Power MOSFET
- 100 % UIS Tested

APPLICATIONS

Load Switch





Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 60	V	
Gate-Source Voltage		V _{GS}	± 20		
	T _C = 25 °C		- 20 ^a		
Continuous Drain Current (T = $150 ^{\circ}$ C)	T _C = 70 °C		- 16		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	- I _D -	- 11 ^b	_	
	T _A = 70 °C		- 9 ^b	A	
Pulsed Drain Current		I _{DM}	- 100		
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	- 35		
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	101	mJ	
Continuous Courses Drain Diada Current	T _C = 25 °C	L.	- 29 ^a	A	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 2.1 ^b		
	T _C = 25 °C		35 ^a		
Maximum Davier Dissis ation	T _C = 70 °C		20 ^a	10/	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.0 ^b	W	
	T _A = 70 °C		2 ^b		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	33	40	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.98	1.2	°C/W	

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface mounted on 1" x 1" FR4 board.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	•				•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		68		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	iD = - 230 μA		- 5.2		111V/ C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zara Cata Voltaga Drain Current	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μA
Zero Gate Voltage Drain Current		V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 120			Α
	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 30 A		0.066		
Drain-Source On-State Resistance ^a		V _{GS} = - 4.5 V, I _D = - 20 A		0.080		Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 50 A	20			S
Dynamic ^b						
Input Capacitance	C _{iss}			1200		pF
Output Capacitance	C _{oss}	V_{DS} = - 25 V, V_{GS} = 0 V, f = 1 MHz		200		
Reverse Transfer Capacitance	C _{rss}			150		
Tatal Cata Charge	Qg	V_{DS} = - 30 V, V_{GS} = - 10 V, I_{D} = - 55 A		40		nC
Total Gate Charge	, e			38		
Gate-Source Charge	Q _{gs}	$V_{\rm DS}$ = - 30 V, $V_{\rm GS}$ = - 4.5 V, $I_{\rm D}$ = - 55 A		16		
Gate-Drain Charge	Q _{gd}			19		
Gate Resistance	Rg	f = 1 MHz		5.2		Ω
Turn-On Delay Time	t _{d(on)}			10	15	
Rise Time	t _r	V_{DD} = - 2 V, R_L = 2 Ω		7	15	- ns
Turn-Off Delay Time	t _{d(off)}	${\rm I}_{\rm D}\cong$ - 10 A, ${\rm V}_{\rm GEN}$ = - 10 V, ${\rm R}_{\rm g}$ = 1 Ω		70	110	
Fall Time	t _f			40	60	
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 66	А
Pulse Diode Forward Current ^a	I _{SM}				- 150	~
Body Diode Voltage	V _{SD}	I _S = - 30 A		- 1	- 1.5	V
Body Diode Reverse Recovery Time	t _{rr}			45	68	ns
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 50 A, di/dt = 100 A/μs, T _{.I} = 25 °C		59	120	nC
Reverse Recovery Fall Time	t _a	$F = -30 \text{ A}, \text{ u/u} = 100 \text{ A/µs}, T_J = 23 ^{\circ}\text{C}$		29		ns
Reverse Recovery Rise Time	t _b			16		

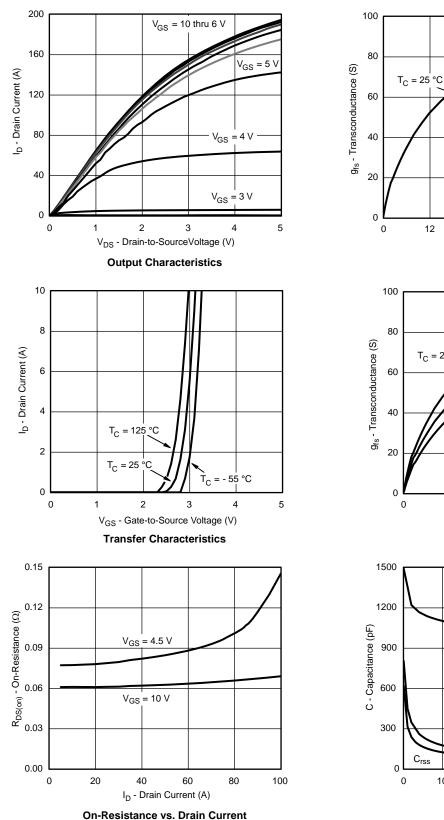
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

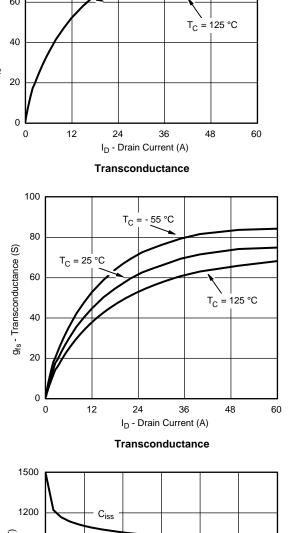
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



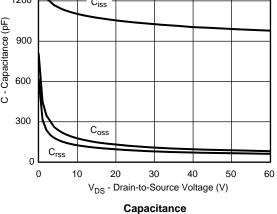


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

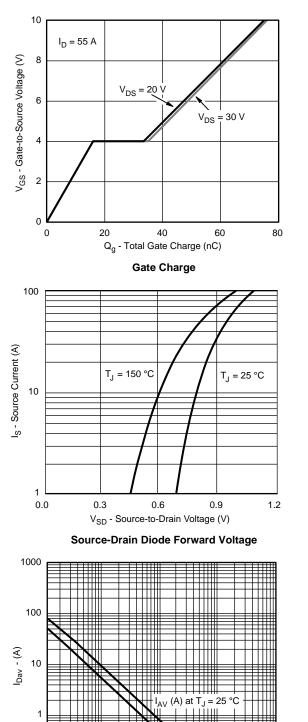


T_C =

- 55 °C







TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $\label{eq:Tin-s} T_{in} \mbox{-} (s)$ Single Pulse Avalanche Current Capability vs. Time

0.01

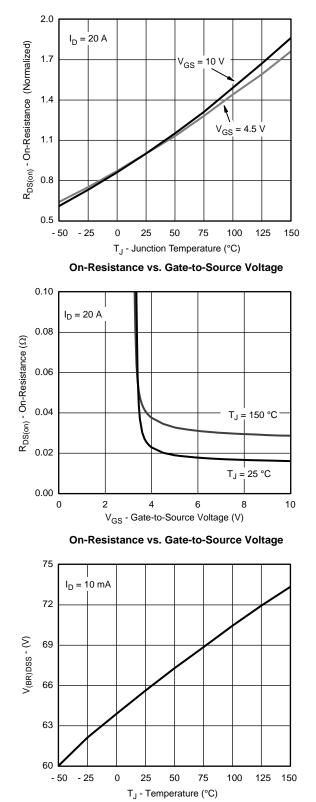
0.1

1

 I_{AV} (A) at T_{J} = 150

0.001

11111

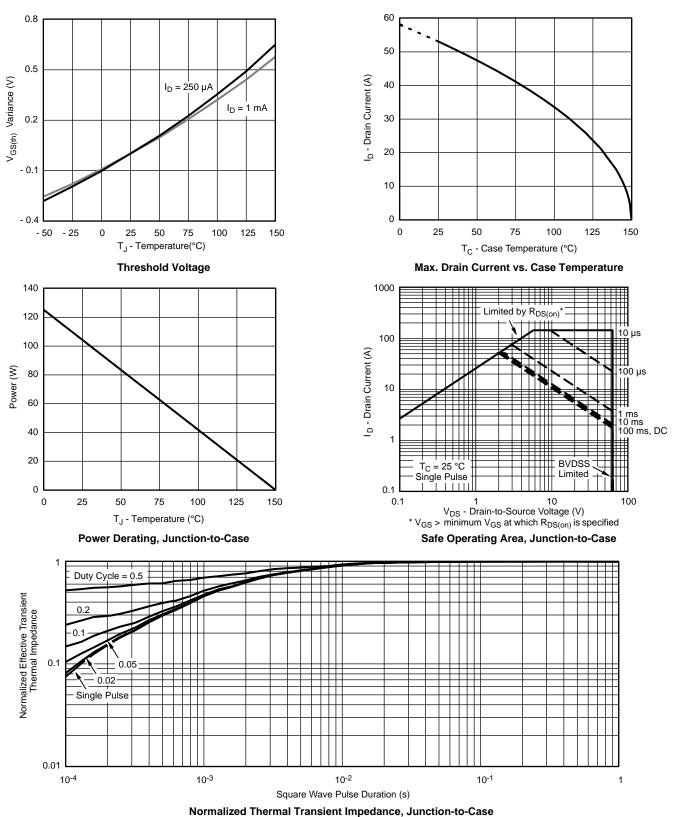


Drain-Source Breakdown Voltage vs. Junction Temperature

0.1

0.0001

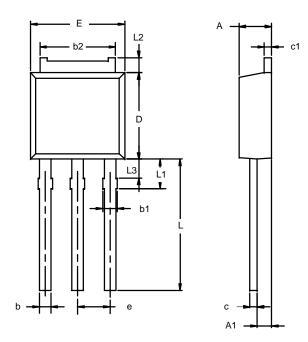




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

Min	Max	Min		
		Min	Max	
2.21	2.38	0.087	0.094	
0.89	1.14	0.035	0.045	
0.71	0.89	0.028	0.035	
0.76	1.14	0.030	0.045	
5.23	5.43	0.206	0.214	
0.46	0.58	0.018	0.023	
0.46	0.58	0.018	0.023	
5.97	6.22	0.235	0.245	
6.48	6.73	0.255	0.265	
2.28 BSC		0.090 BSC		
8.89	9.53	0.350	0.375	
1.91	2.28	0.075	0.090	
0.89	1.27	0.035	0.050	
1.15	1.52	0.045	0.060	
	0.71 0.76 5.23 0.46 0.46 5.97 6.48 2.28 8.89 1.91 0.89 1.15	0.71 0.89 0.76 1.14 5.23 5.43 0.46 0.58 0.46 0.58 5.97 6.22 6.48 6.73 2.28 BSC 8.89 9.53 1.91 2.28 0.89 1.91 2.28 0.89 1.27 1.15 1.52	0.71 0.89 0.028 0.76 1.14 0.030 5.23 5.43 0.206 0.46 0.58 0.018 0.46 0.58 0.018 5.97 6.22 0.235 6.48 6.73 0.255 2.28 BSC 0.090 8.89 9.53 0.350 1.91 2.28 0.075 0.89 1.27 0.035 1.15 1.52 0.045	



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